

RENESAS PSIRT SECURITY ADVISORY ID:202100901

REV.1.1

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RENESAS PSIRT
RENESAS ELECTRONICS CORPORATION

SECURITY ADVISORY [ID:202100901]

DEVICES SUPPORTING BLUETOOTH CORE AND MESH SPECIFICATIONS ARE VULNERABLE TO IMPERSONATION ATTACKS AND AUTHVALUE DISCLOSURE

1.CVEID - CVSS vector [base score]

CVEID	CVSS vector	base score
CVE-2020-26558	CVSS:3.1/AV:A/AC:H/PR:N/UI:N/S:U/C:L/I:L/A:N	4.2
CVE-2020-26560	CVSS:3.1/AV:A/AC:L/PR:N/UI:N/S:U/C:H/I:H/A:N	8.1
CVE-2020-26557	CVSS:3.1/AV:A/AC:H/PR:N/UI:N/S:U/C:H/I:H/A:H	7.5
CVE-2020-26556	CVSS:3.1/AV:A/AC:H/PR:N/UI:N/S:U/C:H/I:H/A:H	7.5
CVE-2020-26559	CVSS:3.1/AV:A/AC:L/PR:N/UI:N/S:U/C:H/I:H/A:H	8.8

*CVE-2020-26555 is not applicable.

2.Publication date

See Item 6.

3.Summary

a. Core

When an attacker makes a man-in-the-middle attack between the pairing initiator and responder in the authentication procedure by Passkey Entry of Bluetooth LE Secure Connections pairing, the attacker estimates the Passkey by using the same public key as the initiator and becomes the initiator resulting in being possible to impersonate.

b. Mesh

In Bluetooth mesh profile specifications v1.0 and 1.0.1, nearby devices that can successfully brute force an AuthValue that is not sufficiently random before the provisioning procedure times out are authenticated by utilizing Malleable Commitments resulting in being possible to complete.

4.Affected products(and versions)

RX23W, RA4W1, RE01B

5.(Potentially)Impacted features

Bluetooth Core and Mesh Specifications.

6.Suggested fixes/actions/mitigations/remediations

- RX23W

- [RX23W Group BLE Module Firmware Integration Technology Application Note - Sample Code | Renesas](#) [21/10/15]
- [RX23W Group Bluetooth Mesh Module Using Firmware Integration Technology Rev.1.20 - Sample Code](#) [21/09/30]
- [RX23W Group Bluetooth Mesh Stack Development Guide Rev.1.20\(renesas.com\)](#) [21/09/30]

- RA4W1

- [Releases · renesas/fsp · GitHub](#) [21/08/31]

- RE01B

- [RE01B Group Bluetooth Low Energy Sample code \(using CMSIS Driver Package\) Application Note - Sample Code | Renesas](#)[21/07/30]

7.Source/External references

<https://kb.cert.org/vuls/id/799380>

<http://jvn.jp/vu/JVNVU99594334/>

Revision	Remarks	Date
1.0	Initial publication.	Jan.31, 2022
1.1	Dead link fixed.	Feb.03, 2022

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